EDA CONSORTIUM ELECTS OFFICERS AND BOARD MEMBERS

SAN JOSE, California, April 16, 2010—The Electronic Design Automation (EDA) Consortium announced today that it has elected a nine-member Board of Directors and officers to serve the organization through spring 2012. Walden C. Rhines, Chairman and CEO of Mentor Graphics Corporation, was re-elected chairman by the new board. Kathryn Kranen, president and CEO of Jasper Design Automation, was re-elected as vice chair, and is joined by Lip-Bu Tan, president and CEO of Cadence Design Systems as a newly elected vice chair.

In addition to the officers, the elected EDA Consortium Board members include:

- **Edmund Cheng**, president and CEO, Gradient Design Automation
- **Dane Collins**, CEO, AWR Corporation
- **Aart de Geus**, chairman and CEO, Synopsys, Inc
- **John Kibarian**, CEO, president and co-founder, PDF Solutions
- **Alex Shubat**, president and CEO, Virage Logic
- **Ravi Subramanian**, president and CEO, Berkeley Design Automation

“Mentor Graphics and its employees have been active participants in EDA Consortium since its inception,” said Wally Rhines. “EDA is a critical part of the semiconductor ecosystem and I look forward to working with the new and returning EDAC board members. Together, we can address the common challenges faced by our members as we advance the EDA and semiconductor industries.”

“The EDA Consortium has been effective in providing a forum for the industry to address common issues, both business and technical” said Ed Cheng. “I look forward to adding my experience and perspective to the EDAC Board as we work together to address new challenges and continue to evolve as an industry.”

“I am looking forward to serving on the EDAC board of directors and to contributing my ideas to the organization,” stated Dane Collins. “My many years of high-frequency engineering and executive experience, as well as my recent work through AWR on EDAC’s anti-piracy committee, will be of benefit as I look to expand the spirit of cooperation and
work with other member companies to uncover solutions and strategies that address the challenges facing our industry.”

“The semiconductor industry is undergoing a transformation with numerous, complex disaggregation and consolidation events. I am excited to join the EDAC board as EDA plays a critical, enabling technology role in the overall electronics design ecosystem,” said Alex Shubat. “I am pleased to contribute my experience first as a designer and EDA user, and more recently as an ecosystem partner and broad line IP provider, to help EDAC drive initiatives that will benefit the talented engineers that are leading innovation in electronics.”

"I am very pleased to be elected to the EDAC Board of Directors,” said Ravi Subramanian, CEO at Berkeley Design Automation. "I look forward to establishing a stronger cooperation between EDAC and semiconductor and electronics industry organizations worldwide."

The new board was elected by the EDA Consortium’s general membership during the voting period ending April 15, 2010. The board chairman was and vice chairmen were elected at a special board meeting held following the Spring Members Meeting on April 15. At the same meeting, the Board also reappointed Robert M. Gardner CFO and Treasurer and Mark White, Partner, White & Lee, LLP, Corporate Secretary.

About the EDA Consortium

The EDA Consortium is the international association of companies that provide tools and services that enable engineers to create the world's electronic products. EDA is the critical technology used to design electronics for the communications, computer, space technology, medical and industrial equipment and consumer electronics markets among others.

For more information about the EDA Consortium or to subscribe to the Market Statistics Service, contact EDA Consortium, 111 West Saint John Street, Suite 220, San Jose, Calif. 95113, USA, office 408-287-3322, fax 408-317-3322 or visit www.edac.org.

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